

# 3 V, SUPER MINIMOLD 1900 MHz SI RFIC AMPLIFIER

## **UPC2749TB**

### **FEATURES**

HIGH DENSITY SURFACE MOUNTING:
 6 pin super minimold or SOT-363 package

· GAIN: 16 dB TYP

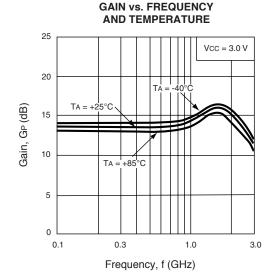
NOISE FIGURE: 4.0 dB TYP

• SUPPLY VOLTAGE: Vcc = 2.7 to 3.3 V

#### **DESCRIPTION**

NEC's UPC2749TB is a Silicon RF Integrated Circuit which is manufactured using the NESAT III process. This device is suitable as a buffer amplifier for GPS, PCS and other communication receivers. The UPC2749TB is pin compatible and has comparable performance as the larger UPC2749T, so it is suitable for use as a replacement to help reduce system size. The IC is housed in a 6 pin super minimold or SOT-363 package.

NEC's stringent quality assurance and test procedures assure the highest reliability and performance.



### **ELECTRICAL CHARACTERISTICS** (TA = $25^{\circ}$ C, ZL = Zs = $50 \Omega$ , Vcc = 3.0 V)

PART NUMBER PACKAGE OUTLINE					UPC2749TB SO6		
SYMBOLS	PARAMETERS AND CONDITIONS UNIT		UNITS	MIN	TYP	MAX	
Icc	Circuit Current (no signal)		mA	4	6	8	
Gs	Small Signal Gain,	f = 900 MHz f = 1900 MHz	dB dB	13	14.5 16	18.5	
fu <sup>1</sup>	Upper Limit Operating Freq	uency	GHz	2.5	2.9		
P <sub>1dB</sub>	1 dB Compressed Output P	dBm		-12.5			
Psat	Saturated Output Power,	f = 1900 MHz	dBm	-9	-6		
NF	Noise Figure,	f = 900 MHz f = 1900 MHz	dB dB		3.2 4.0	5.5	
RLIN	Input Return Loss,	f = 1900 MHz	dB	7	10		
RLout	Output Return Loss,	f = 1900 MHz	dB	9.5	12.5		
ISOL	Isolation,	f = 1900 MHz	dB	25	30		
OIP3	SSB Output Third Order Into	ercept, f1 = 1900 MHz, f2 = 1902 MHz	dBm		-3.5		
RTH (J-A)	Thermal Resistance (Junction Mounted on a 5	on to Ambient) 0 x 50 x 1.6 mm epoxy glass PWB	°C/W			325	

#### Note:

California Eastern Laboratories

<sup>1.</sup>The gain at fu is 3 dB down from the gain at 1900 MHz.

### ABSOLUTE MAXIMUM RATINGS<sup>1</sup> (TA = 25°C)

SYMBOLS	PARAMETERS	UNITS	RATINGS
Vcc	Supply Voltage	V	4.0
Icc	Total Supply Current	mA	15
Pin	Input Power	dBm	0
Рт	Total Power Dissipation <sup>2</sup>	mW	200
Тор	Operating Temperature	°C	-40 to +85
Тѕтс	Storage Temperature	°C	-55 to +150

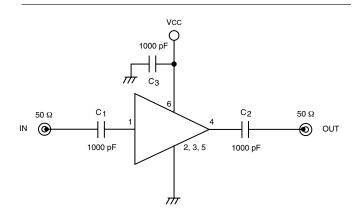
#### Notes:

- 1. Operation in excess of any one of these parameters may result in permanent damage.
- 2. Mounted on a  $50 \times 50 \times 1.6$  mm epoxy glass PWB (TA = 85°C).

### **RECOMMENDED OPERATING CONDITIONS**

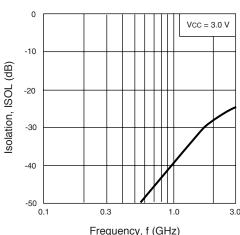
SYMBOLS	PARAMETERS	UNITS	MIN	TYP	MAX
Vcc	Supply Voltage	V	2.7	3	3.3
Тор	Operating Temperature	°C	-40	25	85

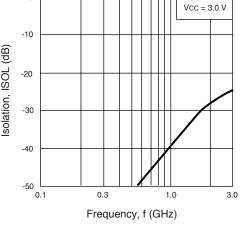
### **TEST CIRCUIT**



### TYPICAL PERFORMANCE CURVES (TA = 25°C)

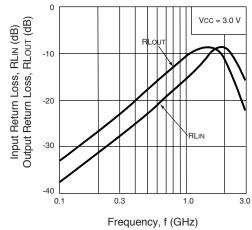




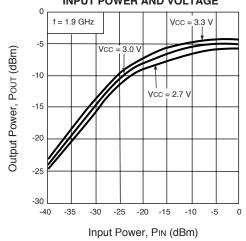




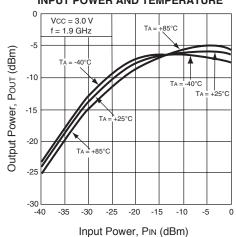
**INPUT RETURN LOSS AND OUTPUT RETURN LOSS vs. FREQUENCY** 



#### **OUTPUT POWER vs. INPUT POWER AND VOLTAGE**

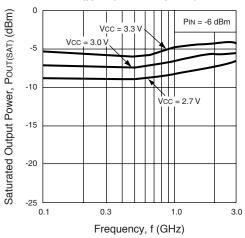


#### **OUTPUT POWER vs. INPUT POWER AND TEMPERATURE**

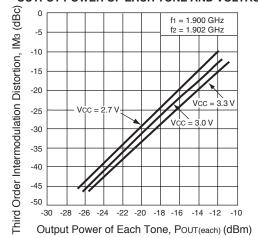


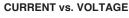
### TYPICAL PERFORMANCE CURVES (TA = 25°C)

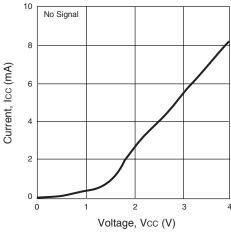




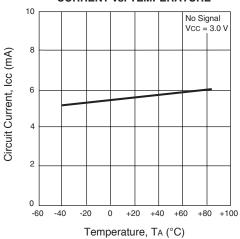
# THIRD ORDER INTERMODULATION DISTORTION vs. OUTPUT POWER OF EACH TONE AND VOLTAGE



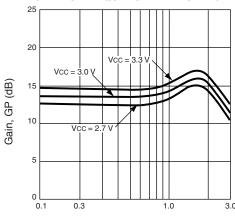




#### **CURRENT vs. TEMPERATURE**

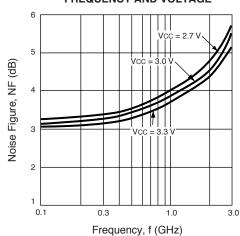


#### **GAIN vs. FREQUENCY AND VOLTAGE**



Frequency, f (GHz)

# NOISE FIGURE vs. FREQUENCY AND VOLTAGE

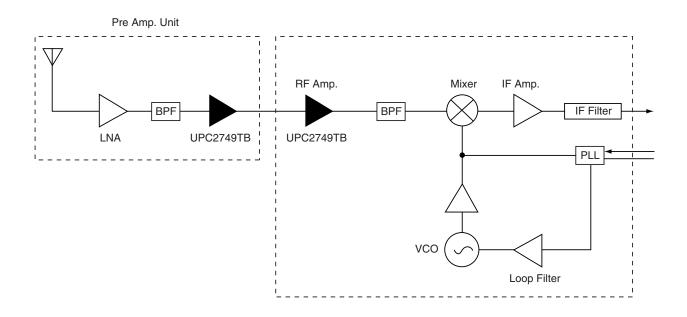


### **PIN DESCRIPTION**

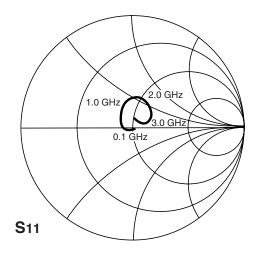
Pin No.	Pin Name	Applied Voltage (V)	Pin Voltage (V)	Description	Internal Equivalent Circuit
1	Input	-	0.82	Signal input pin. An internal matching circuit, configured with resistors, enables $50~\Omega$ connection over a wide bandwidth. A multi-feedback circuit is designed to cancel the deviations of hFE and resistance. This pin must be coupled to the signal source with a blocking capacitor.	O VCC
4	Output	-	2.87	Signal output pin. An internal matching circuit, configured with resistors, enables 50 $\Omega$ connection over a wide bandwidth. This pin must be coupled to the output load with a blocking capacitor.	O OUT
6	Vcc	2.7 to 3.3	-	Power supply pin. This pin should be externally equipped with a bypass capacitor to minimize ground impedance.	3 O 2 O GND 5
2 3 5	GND	0	-	Ground pins. These pins should be connected to system ground with minimum inductance. Ground pattern on the board should be formed as wide as possible. All the ground pins must be connected together with wide ground pattern to minimize impedance difference.	

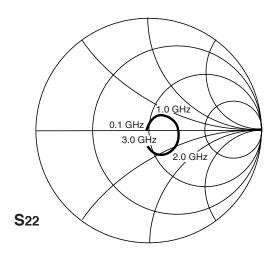
### **SYSTEM APPLICATION EXAMPLE**

### **Example of GPS Receiver**



### TYPICAL SCATTERING PARAMETERS (TA = 25°C)





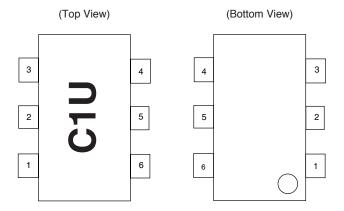
Vcc = 3.0 V, Icc = 6.5 mA\_

REQUENCY		S11	S2	11	s	12	s	22	K
GHz	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG	
0.1	0.021	13.0	4.096	-1.9	0.002	-1.1	0.024	165.8	66.82
0.2	0.038	-30.5	4.216	-7.8	0.001	75.4	0.033	113.6	129.26
0.3	0.034	-71.8	4.282	-15.5	0.001	141.5	0.064	96.1	90.16
0.4	0.052	-120.5	4.403	-21.0	0.002	129.9	0.080	87.9	45.30
0.5	0.062	-149.9	4.390	-26.6	0.002	134.1	0.103	76.9	57.58
0.6	0.079	-169.7	4.399	-31.6	0.003	128.3	0.127	68.6	34.08
0.7	0.097	173.6	4.566	-36.7	0.005	132.9	0.151	60.6	22.08
0.8	0.116	160.5	4.667	-41.3	0.007	131.5	0.174	53.7	14.70
0.9	0.134	149.3	4.843	-46.8	0.008	129.3	0.197	44.9	12.29
1.0	0.156	138.8	5.016	-52.6	0.009	124.6	0.220	36.1	10.00
1.1	0.178	128.5	5.305	-60.3	0.014	131.4	0.240	28.0	6.15
1.2	0.195	118.7	5.660	-67.1	0.016	122.5	0.262	17.3	5.13
1.3	0.214	108.7	5.835	-76.2	0.020	118.6	0.279	8.6	3.80
1.4	0.229	99.5	6.148	-84.5	0.022	114.4	0.287	-2.0	3.23
1.5	0.249	89.4	6.364	-93.8	0.025	107.7	0.294	-13.5	2.72
1.6	0.259	79.9	6.611	-103.6	0.028	104.3	0.294	-23.6	2.35
1.7	0.264	69.8	6.577	-113.5	0.032	96.8	0.283	-33.8	2.09
1.8	0.259	60.3	6.549	-123.4	0.034	91.8	0.272	-44.1	1.99
1.9	0.248	50.9	6.407	-132.9	0.036	83.3	0.036	-53.8	1.97
2.0	0.238	43.6	6.321	-140.8	0.037	78.5	0.234	-61.4	1.99
2.1	0.218	35.9	6.046	-148.8	0.038	75.1	0.213	-69.5	2.04
2.2	0.204	30.1	5.862	-156.5	0.039	70.4	0.193	-73.8	2.08
2.3	0.183	25.3	5.696	-163.2	0.040	68.3	0.174	-79.5	2.15
2.4	0.156	21.2	5.430	-170.5	0.041	60.7	0.164	-84.1	2.25
2.5	0.140	18.8	5.282	-176.3	0.042	61.6	0.152	-82.1	2.25
2.6	0.119	18.7	5.013	177.2	0.040	58.1	0.142	-84.5	2.53
2.7	0.095	21.2	4.849	170.9	0.042	55.1	0.146	-85.5	2.46
2.8	0.078	30.0	4.596	164.9	0.042	51.9	0.149	-83.9	2.62
2.9	0.066`	44.5	4.446	158.1	0.042	44.7	0.154	-91.8	2.70
3.0	0.070	66.0	4.163	152.3	0.044	41.9	0.171	-92.8	2.73
3.1	0.082	78.1	3.966	145.3	0.042	37.1	0.181	-99.6	2.97

### **OUTLINE DIMENSIONS** (Units in mm)

# 

### **LEAD CONNECTIONS**



- 1. INPUT
- 2.. GND
- 3. GND
- 4. OUTPUT
- 5. GND
- 6. Vcc

#### ORDERING INFORMATION

PART NUMBER	MARKING	QTY	
UPC2749TB-E3-A	CIU	3K/Reel	

Note:

Embossed Tape, 8 mm wide. Pins 1, 2 and 3 face perforated side of tape.

Life Support Applications

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Subject: Compliance with EU Directives

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CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (\*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices		
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)	
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

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